

Basic information	
<b>2013/2918(DEA)</b> DEA - Delegated acts procedure	Procedure completed - delegated act enters into force
Exemption for lead in solders, termination coatings of electrical and electronic components and printed circuit boards, connections of electrical wires, shields and enclosed connectors  Supplementing <a href="#">2008/0240(COD)</a>  <b>Subject</b>  3.40.06 Electronics, electrotechnical industries, ICT, robotics 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)	

Technical information	
<b>Procedure reference</b>	2013/2918(DEA)
<b>Procedure type</b>	DEA - Delegated acts procedure
<b>Procedure subtype</b>	Examination of delegated act
<b>Amendments and repeals</b>	Supplementing <a href="#">2008/0240(COD)</a>
<b>Stage reached in procedure</b>	Procedure completed - delegated act enters into force
<b>Committee dossier</b>	ENVI/7/14385